

## Thyristor

Low Power Use

REJ03G0352-0200

Rev.2.00

Mar.01.2005

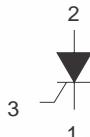
## Features

- $I_{T(AV)}$  : 0.3 A
- $V_{DRM}$  : 600 V
- $I_{GT}$  : 100  $\mu$ A

- Non-Insulated Type
- Glass Passivation Type

## Outline

PRSS0003EA-A  
(Package name:TO-92)



- Cathode
- Anode
- Gate

## Applications

Leakage protector, timer, and gas igniter

## Maximum Ratings

Parameter	Symbol	Voltage class		Unit
		12		
Repetitive peak reverse voltage	$V_{RRM}$	600		V
Non-repetitive peak reverse voltage	$V_{RSM}$	800		V
DC reverse voltage	$V_{R(DC)}$	480		V
Repetitive peak off-state voltage <sup>Note1</sup>	$V_{DRM}$	600		V
Non-repetitive peak off-state voltage <sup>Note1</sup>	$V_{DSM}$	800		V
DC off-state voltage <sup>Note1</sup>	$V_{D(DC)}$	480		V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	$I_T$ (RMS)	0.47	A	
Average on-state current	$I_T$ (AV)	0.3	A	Commercial frequency, sine half wave 180° conduction, $T_a = 47^\circ C$
Surge on-state current	$I_{TSM}$	20	A	60Hz sine half wave 1 full cycle, peak value, non-repetitive
$I^2t$ for fusing	$I^2t$	1.6	$A^2s$	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	$P_{GM}$	0.5	W	
Average gate power dissipation	$P_G$ (AV)	0.1	W	
Peak gate forward voltage	$V_{FGM}$	6	V	
Peak gate reverse voltage	$V_{RGM}$	6	V	
Peak gate forward current	$I_{FGM}$	0.3	A	
Junction temperature	$T_j$	-40 to +110	°C	
Storage temperature	$T_{stg}$	-40 to +125	°C	
Mass	—	0.23	g	Typical value

Notes: 1. With gate to cathode resistance  $R_{GK} = 1 k\Omega$ .

## Electrical Characteristics

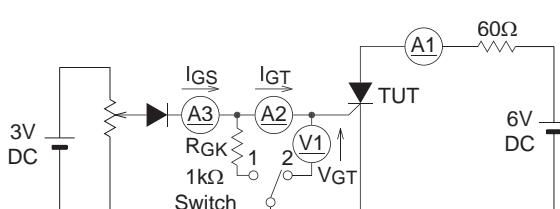
Parameter	Symbol	Min.	Typ.	Max.	Unit	Test conditions
Repetitive peak reverse current	$I_{RRM}$	—	—	0.1	mA	$T_j = 110^\circ C$ , $V_{RRM}$ applied
Repetitive peak off-state current	$I_{DRM}$	—	—	0.1	mA	$T_j = 110^\circ C$ , $V_{DRM}$ applied, $R_{GK} = 1 k\Omega$
On-state voltage	$V_{TM}$	—	—	1.8	V	$T_a = 25^\circ C$ , $I_{TM} = 4 A$ , instantaneous value
Gate trigger voltage	$V_{GT}$	—	—	0.8	V	$T_j = 25^\circ C$ , $V_D = 6 V$ , $I_T = 0.1 A$ <sup>Note3</sup>
Gate non-trigger voltage	$V_{GD}$	0.2	—	—	V	$T_j = 110^\circ C$ , $V_D = 1/2 V_{DRM}$ , $R_{GK} = 1 k\Omega$
Gate trigger current	$I_{GT}$	1	—	100 <sup>Note2</sup>	μA	$T_j = 25^\circ C$ , $V_D = 6 V$ , $I_T = 0.1 A$ <sup>Note3</sup>
Holding current	$I_H$	—	1.5	3	mA	$T_j = 25^\circ C$ , $V_D = 12 V$ , $R_{GK} = 1 k\Omega$
Thermal resistance	$R_{th(j-a)}$	—	—	180	°C/W	Junction to ambient

Notes: 2. If special values of  $I_{GT}$  are required, choose item D or E from those listed in the table below if possible.

Item	A	B	C	D	E
$I_{GT}$ (μA)	1 to 30	20 to 50	40 to 100	1 to 50	20 to 100

The above values do not include the current flowing through the  $1 k\Omega$  resistance between the gate and cathode.

3  $I_{GT}$ ,  $V_{GT}$  measurement circuit.



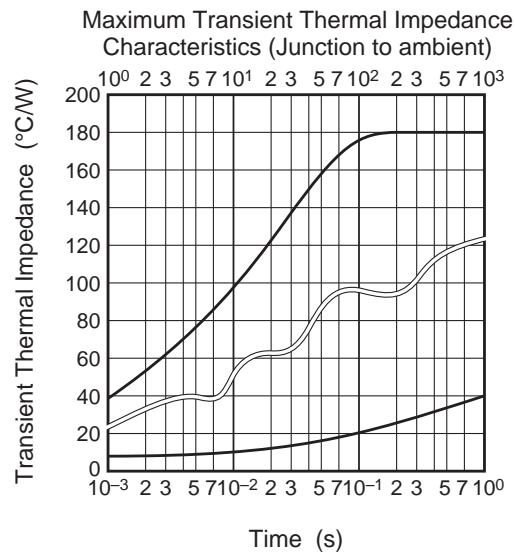
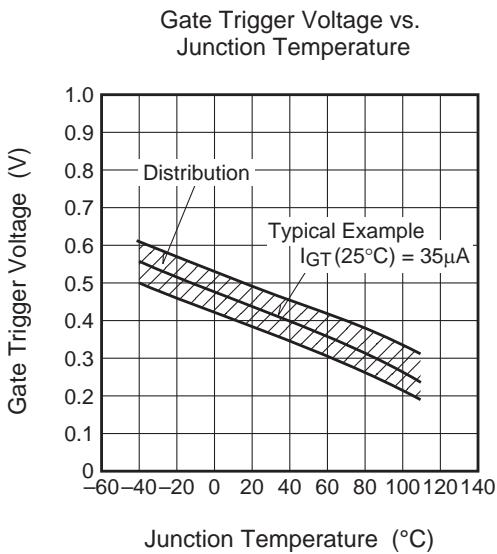
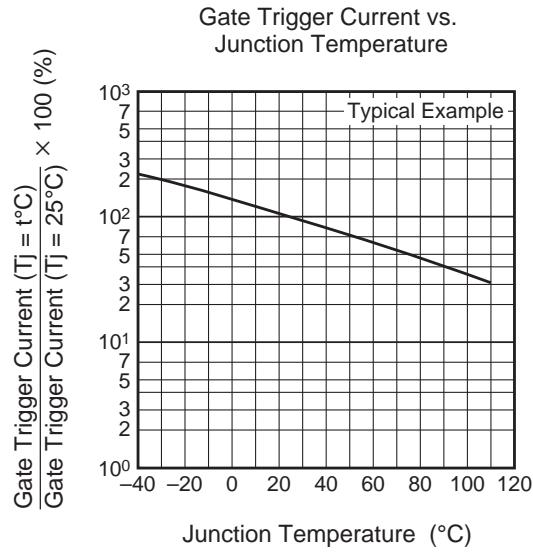
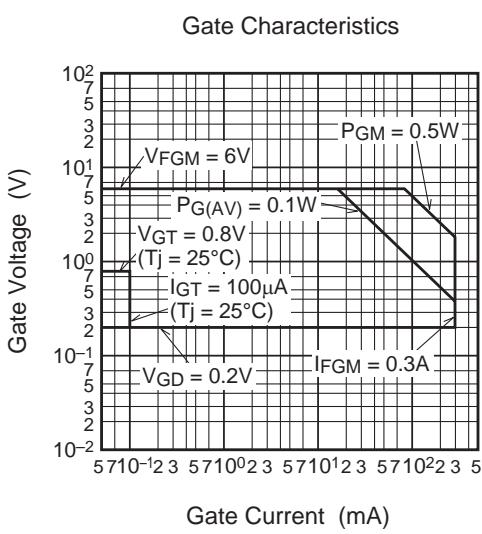
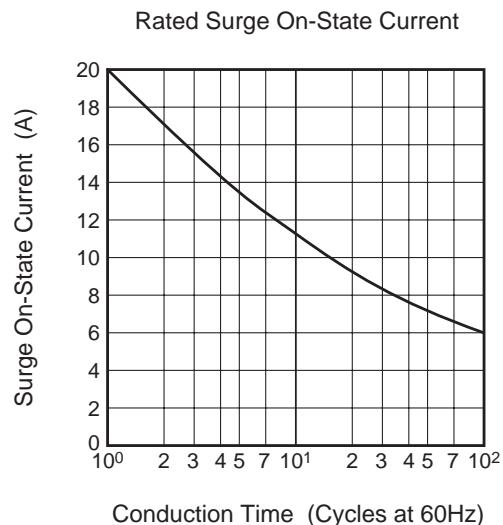
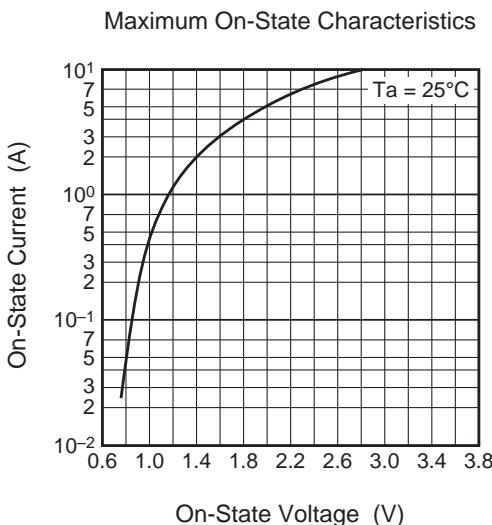
Switch 1 :  $I_{GT}$  measurement

Switch 2 :  $V_{GT}$  measurement

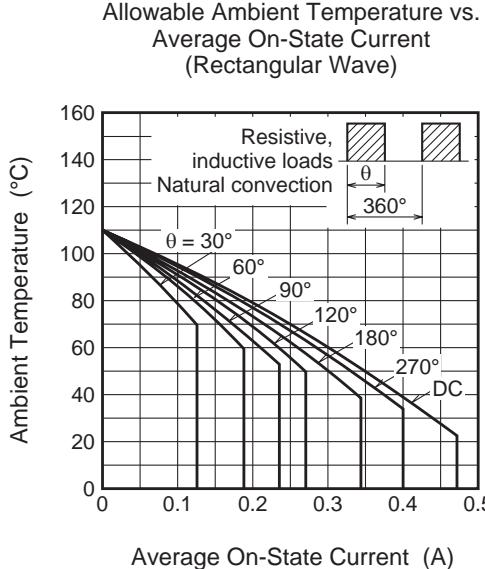
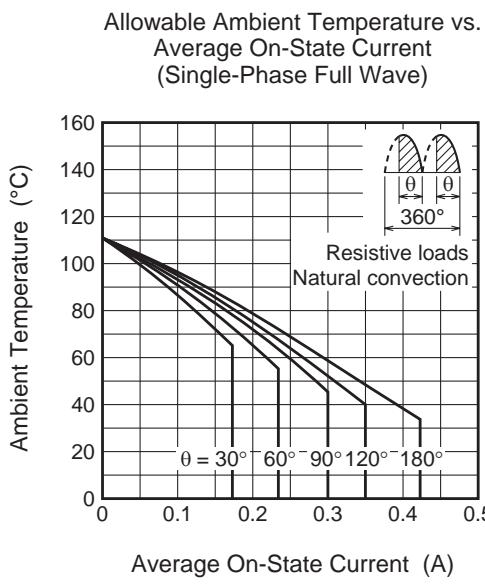
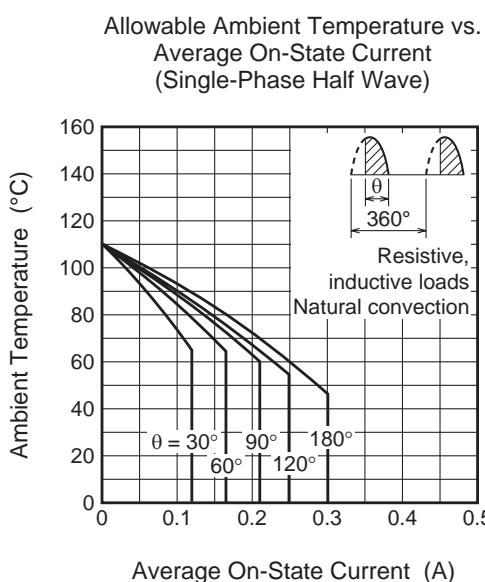
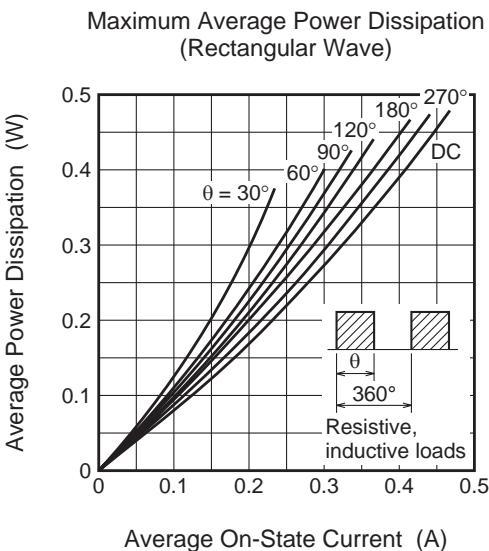
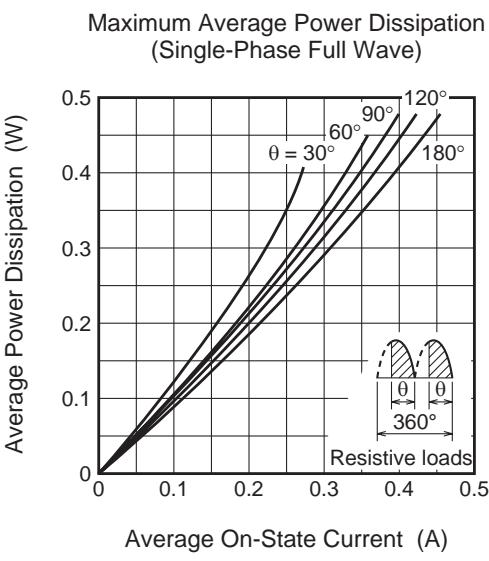
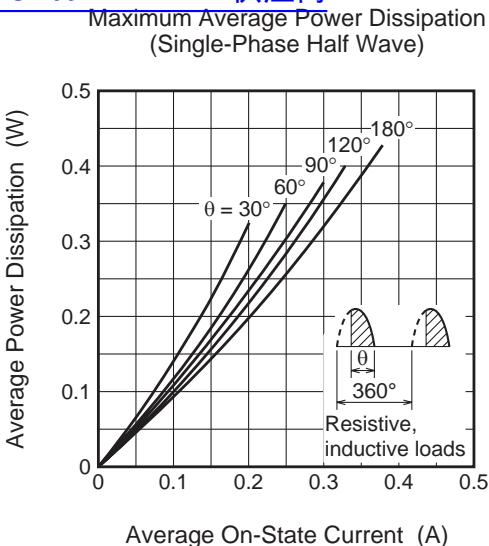
(Inner resistance of voltage meter is about  $1 k\Omega$ )

## Performance Curves

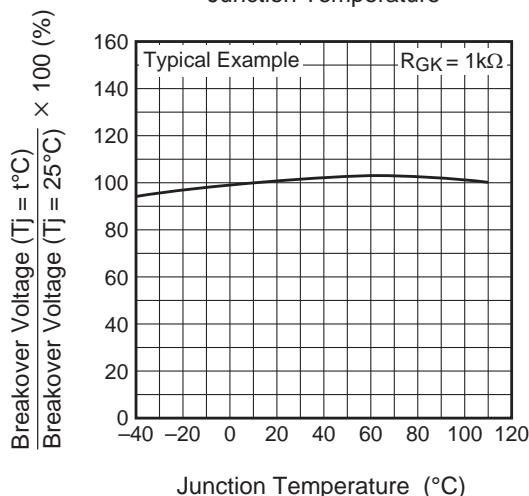
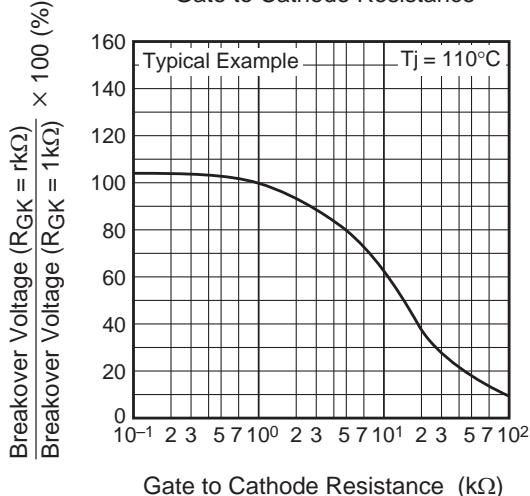
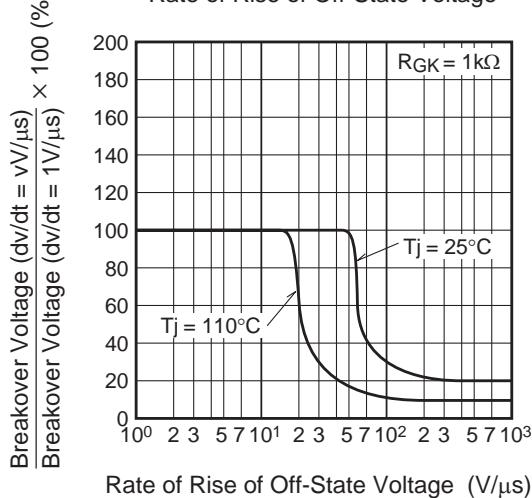
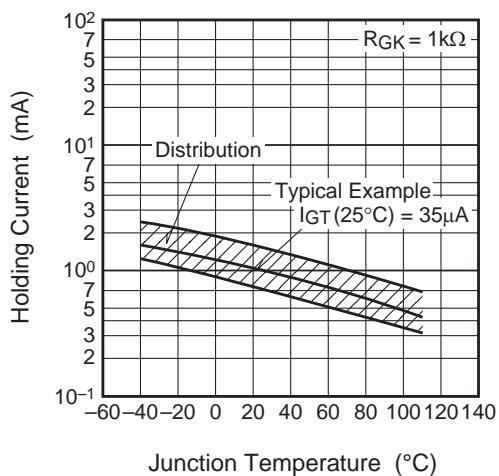
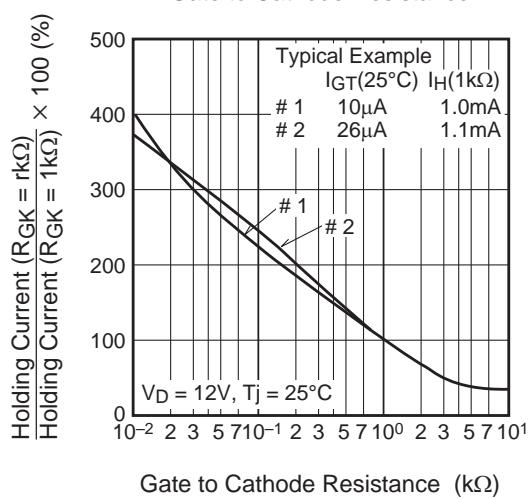
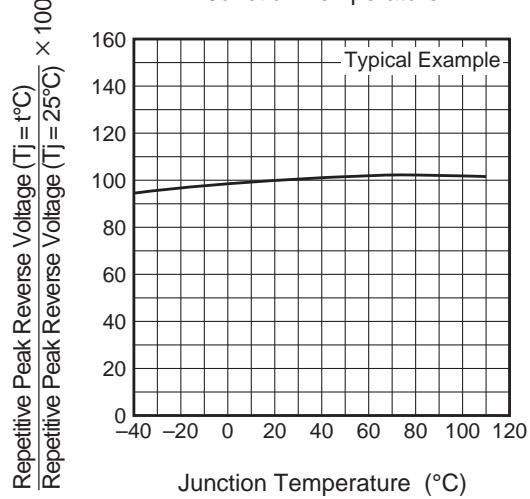
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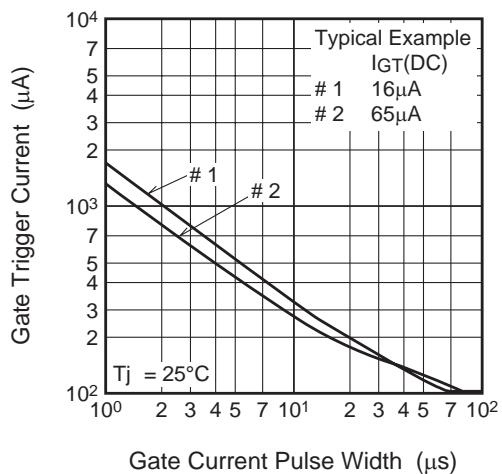
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Breakover Voltage vs.  
Junction TemperatureBreakover Voltage vs.  
Gate to Cathode ResistanceBreakover Voltage vs.  
Rate of Rise of Off-State VoltageHolding Current vs.  
Junction TemperatureHolding Current vs.  
Gate to Cathode ResistanceRepetitive Peak Reverse Voltage vs.  
Junction Temperature

查询"CR03AM-12-TB"供应商  
Gate Trigger Current vs.  
Gate Current Pulse Width



## Packaging Dimensions

JEITA Package Code	RENESAS Code	Package Name	MASS(Typ.)	Unit: mm
SC-43A	PRSS0003EA-A	TO-92	0.23g	

Dimensions shown in mm:

- Total width: 4.4
- Total height: 5.0 Max, 11.5 Min
- Lead thickness: 1.1
- Lead pitch: 1.25
- Circumscribed circle diameter: 0.7
- Lead width: 1.25

## Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name	CR03AM-12
Lead form	Vinyl sack	500	Type name – Lead forming code	CR03AM-12-A6
Form A8	Taping	2000	Type name – TB	CR03AM-12-TB

Note : Please confirm the specification about the shipping in detail.

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